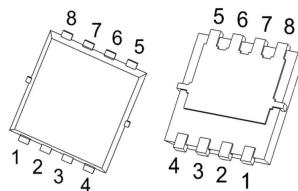


40V N-Channel Mosfet

FEATURES

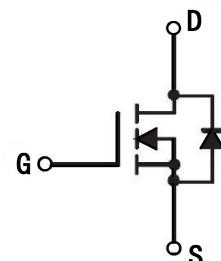
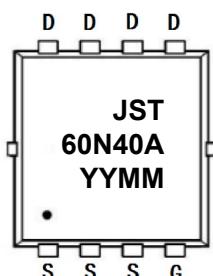
- $R_{DS(ON)} \leq 8.5 \text{ m}\Omega$ (6.0 $\text{m}\Omega$ Typ.)
@ $V_{GS}=10\text{V}$
- $R_{DS(ON)} \leq 15 \text{ m}\Omega$ (8.8 $\text{m}\Omega$ Typ.)
@ $V_{GS}=4.5\text{V}$
- AEC Q101 qualified
- Green Product (RoHS compliant)
- 100% UIS TEST

PDFNWB3.3*3.3-8L

1: S 3: S 5: D 7: D
2: S 4: G 6: D 8: D

APPLICATIONS

- Automotive Systems
- PWM Applications
- Load Switch
- Power Management

N-CHANNEL MOSFET**MARKING**

YYMM: Date Code(year & month)

Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Max.	Units
V_{DSS}	Drain-Source Voltage	40	V
V_{GSS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current @ $V_{GS}=10\text{V}$ ^{note1}	50	A
		35	A
I_{DM}	Pulsed Drain Current ^{note2}	200	A
E_{AS}	Single Pulsed Avalanche Energy ^{note3}	32	mJ
P_D	Power Dissipation $ T_c = 25^\circ\text{C}$	43	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.5	$^\circ\text{C}/\text{W}$
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +175	$^\circ\text{C}$

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
Off Characteristic						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	40	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=40\text{V}, V_{GS}=0\text{V},$	-	-	1.0	μA
I_{GSS}	Gate to Body Leakage Current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$	-	-	± 100	nA
On Characteristics						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.0	1.5	2.5	V
$R_{DS(\text{on})}$	Static Drain-Source on-Resistance note4	$V_{GS}=10\text{V}, I_D=30\text{A}$	-	6.0	8.5	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=20\text{A}$	-	8.8	15	
Dynamic Characteristics note5						
C_{iss}	Input Capacitance	$V_{DS}=20\text{V}, V_{GS}=0\text{V}, f=1.0\text{MHz}$	-	820	-	pF
C_{oss}	Output Capacitance		-	323	-	pF
C_{rss}	Reverse Transfer Capacitance		-	87	-	pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	-	6.5	-	Ω
Q_g	Total Gate Charge	$V_{DS}=20\text{V}, I_D=30\text{A}, V_{GS}=10\text{V}$	-	13.1	-	nC
Q_{gs}	Gate-Source Charge		-	4.2	-	nC
Q_{gd}	Gate-Drain("Miller") Charge		-	1.8	-	nC
Switching Characteristics note5						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=20\text{V}, I_D=30\text{A}, R_{GEN}=3\Omega, V_{GS}=10\text{V}$	-	8.1	-	ns
t_r	Turn-on Rise Time		-	6.3	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	28	-	ns
t_f	Turn-off Fall Time		-	8	-	ns
Drain-Source Diode Characteristics and Maximum Ratings						
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS}=0\text{V}, I_S=30\text{A}$	-	0.8	1.2	V
t_{rr}	Body Diode Reverse Recovery Time	$T_J=25^\circ\text{C}, I_F=20\text{A}, dI/dt=100\text{A}/\mu\text{s}$	-	12	-	ns
Q_{rr}	Body Diode Reverse Recovery Charge		-	4	-	nC

Notes: 1. $T_c=25^\circ\text{C}$ Limited only by maximum temperature allowed. Calculated continuous current based on maximum allowable junction temperature.

2. $PW \leq 10\mu\text{s}$, Duty cycle $\leq 1\%$
- 3 . EAS condition: $V_{DD}=20\text{V}, V_G=10\text{V}, I_D=8\text{A}, L=1\text{mH}$ starting $T_j=25^\circ\text{C}$.
- 4 . Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$
- 5 . Guaranteed by design, not subject to production testing

Typical Performance Characteristics

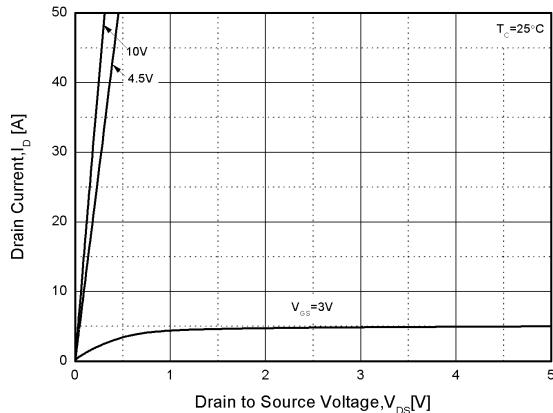


Figure1. Output Characteristics

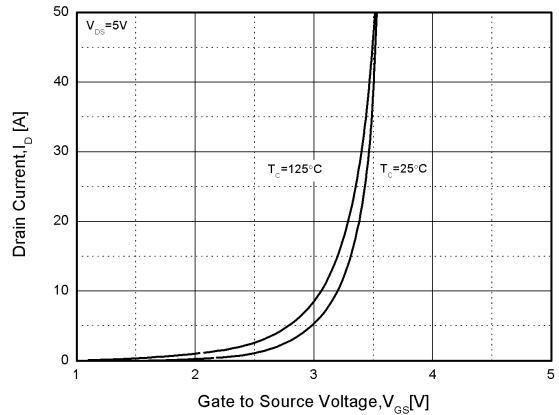


Figure2. Transfer Characteristics

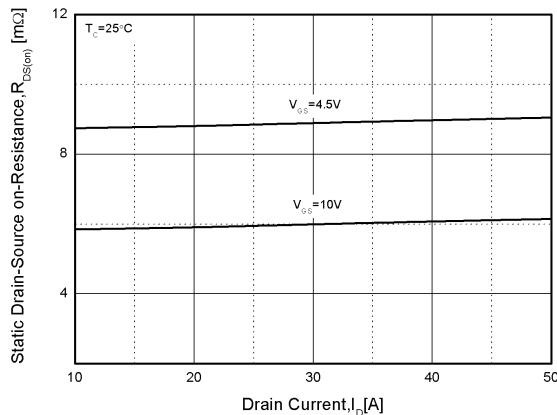


Figure3. Rdson-Drain Current

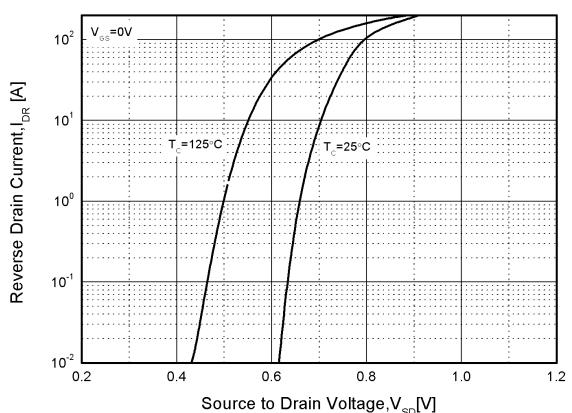


Figure4. Typical Source-Drain Diode Forward Voltage

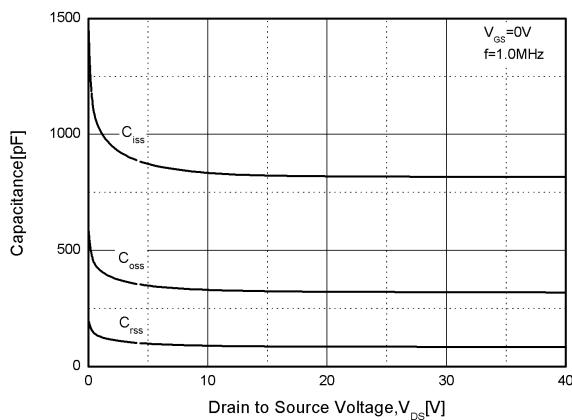


Figure5. Capacitance Characteristics

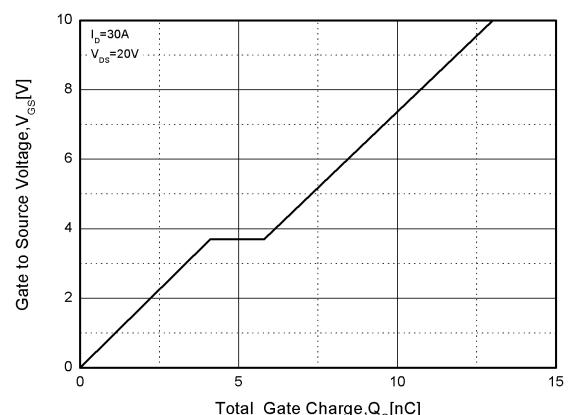


Figure6. Gate Charge

TYPICAL PERFORMANCE CHARACTERISTICS (cont.)

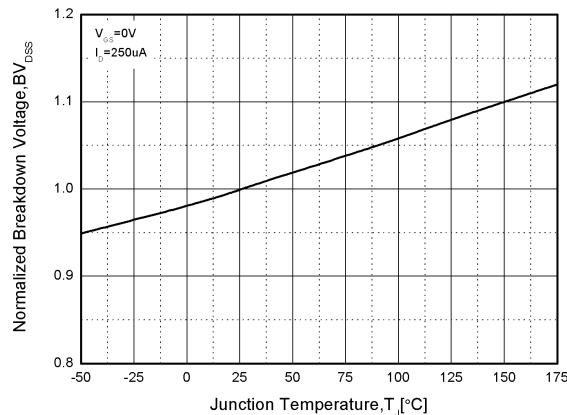


Figure 7. Normalized Breakdown Voltage vs. Temperature

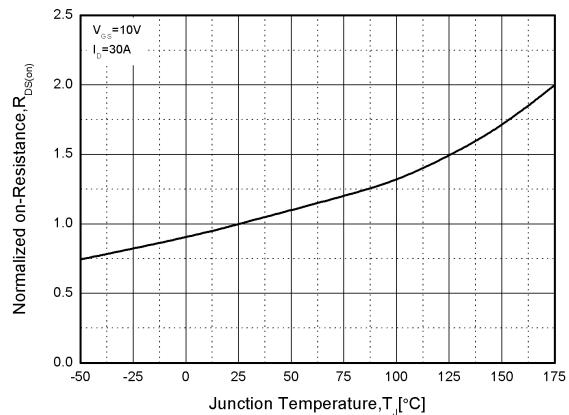


Figure 8. Normalized on Resistance vs. Temperature

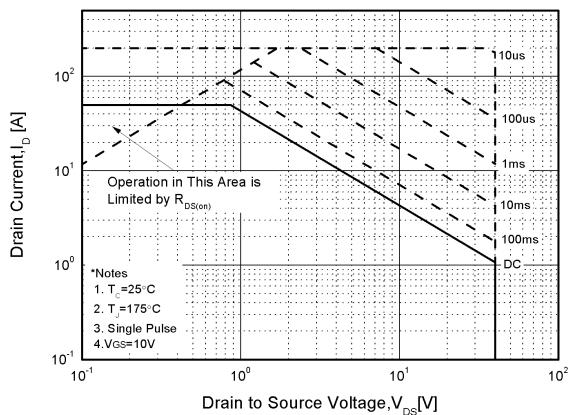


Figure 9. Safe Operation Area

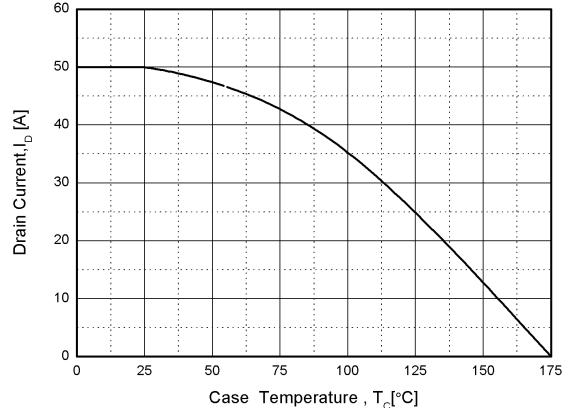


Figure 10. Drain Current vs. Case Temperature

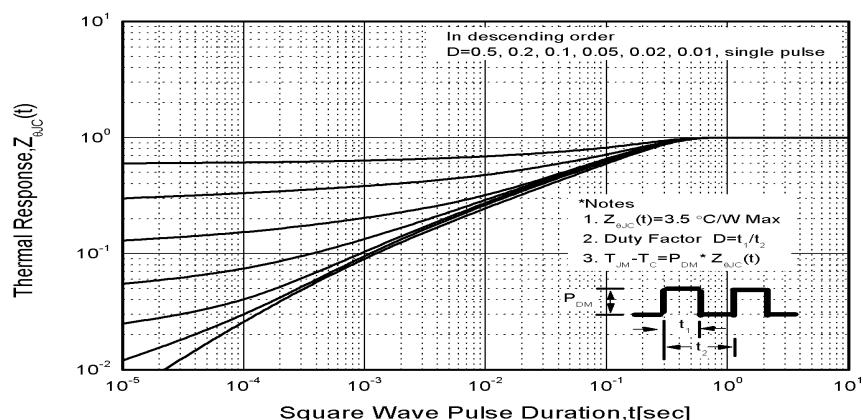
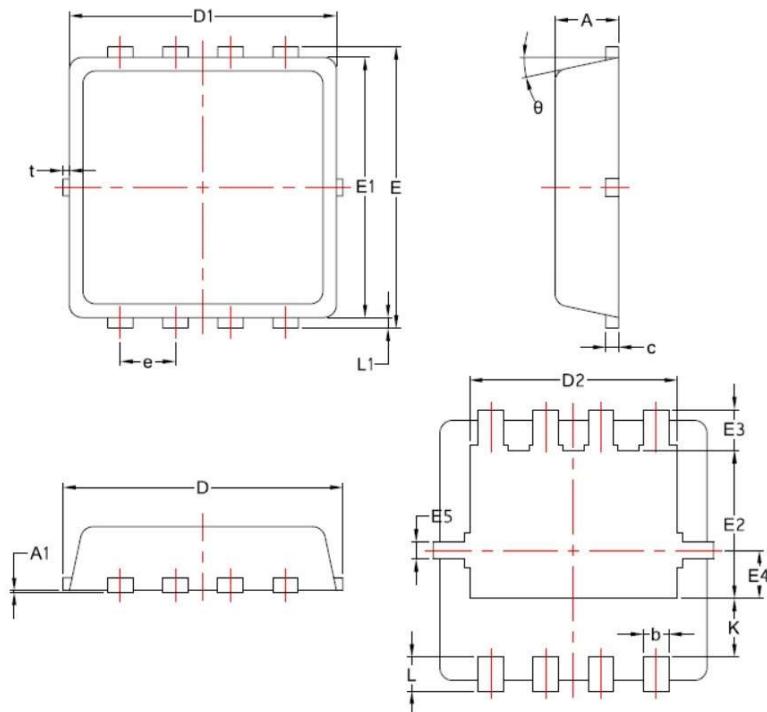


Figure 11. Transient Thermal Response Curve

PDFNWB3.3*3.3-8L Package Outline Dimensions



Symbols	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.70	0.75	0.85	0.028	0.030	0.033
A1	---	---	0.05	---	---	0.002
b	0.20	0.30	0.40	0.008	0.012	0.016
c	0.10	0.152	0.25	0.004	0.152	0.010
D	3.15	3.30	3.45	0.124	0.130	0.136
D1	3.00	3.15	3.25	0.118	0.124	0.128
D2	2.29	2.45	2.65	0.090	0.096	0.104
E	3.15	3.30	3.45	0.124	0.130	0.136
E1	2.90	3.05	3.20	0.114	0.120	0.126
E2	1.54	1.74	1.94	0.060	0.069	0.076
E3	0.28	0.48	0.65	0.011	0.019	0.026
E4	0.37	0.57	0.77	0.015	0.022	0.030
E5	0.10	0.20	0.30	0.004	0.008	0.012
e	0.60	0.65	0.70	0.024	0.026	0.028
K	0.59	0.69	0.89	0.023	0.027	0.035
L	0.30	0.40	0.50	0.012	0.016	0.020
L1	0.06	0.125	0.20	0.002	0.005	0.008
t	0	0.075	0.13	0	0.003	0.005
θ	10°	12°	14°	10°	12°	14°